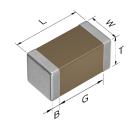
积层贴片陶瓷片式电容器

C1608X6S1E334K080AB

RoHS Reach Halogen Free Pb Free

交货型号	C1608X6S1E334KT****	
用途	一般等级	
特点	General 一般 (~75V)	
系列	C1608 [EIA 0603]	
状态	▲ 量产体制(新设计非推荐)	



尺寸		
长度(L)	1.60mm ±0.10mm	
宽度(W)	0.80mm ±0.10mm	
厚度(T)	0.80mm ±0.10mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.30mm Min.	
推荐焊盘布局(PA)	0.70mm to 1.00mm(Flow Soldering)	
1世仔/严益41/四 (FA)	0.60mm to 0.80mm(Reflow Soldering)	
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)	
J世代·严益·仰/四(t D)	0.60mm to 0.80mm(Reflow Soldering)	
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)	
1世行/开血/印/미 (t U/	0.60mm to 0.80mm(Reflow Soldering)	

电 ⁴	气特性
电容	330nF ±10%
额定电压	25VDC
温度特性	X6S (±22%)
耗散因数 (Max.)	5%
	1515ΜΩ

	其他	
焊接方法	流体	
汗 按刀莅	回流	
AEC-Q200	NO	
包装形式	纸编带 (180mm卷筒)	
包装个数	4000pcs	

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

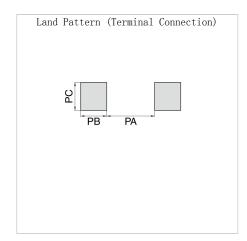
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Associated Images



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